

N-channel 30 V 4.3 m Ω logic level MOSFET

Rev. 01 — 16 June 2009

Product data sheet

1. Product profile

1.1 General description

Logic level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- **1.3 Applications**
 - DC-to-DC converters
 - Load switiching

1.4 Quick reference data

 Suitable for logic level gate drive sources

nexperia

- Motor control
- Server power supplies

Table 1.	Quick reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	30	V
I _D	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u>	<u>[1]</u>	-	-	100	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	103	W
Dynamic	characteristics						
Q _{GD}	gate-drain charge	$\label{eq:VGS} \begin{array}{l} V_{GS} = 4.5 \text{ V}; \text{ I}_{D} = 25 \text{ A}; \\ V_{DS} = 15 \text{ V}; \text{ see } \underline{\text{Figure } 14}; \\ \text{see } \underline{\text{Figure } 15} \end{array}$		-	5	-	nC
Static ch	aracteristics						
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 13</u>	[2]	-	3.5	4.3	mΩ

[1] Continuous current is limited by package.

[2] Measured 3 mm from package.

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	
3	S	source	205	
	D	mounting base; connected to drain		mbb076 S
			SOT78	

(TO-220AB; SC-46)

3. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PSMN4R3-30PL	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78			

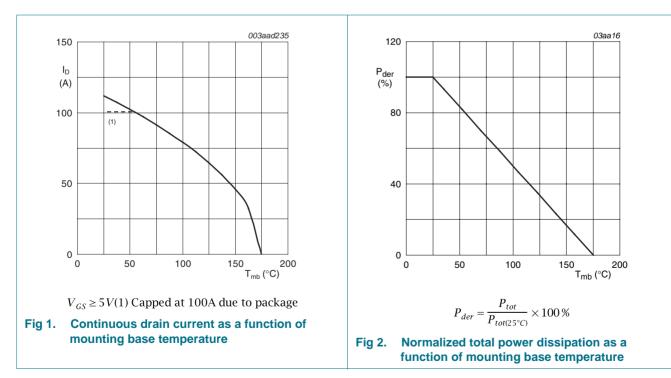
4. Limiting values

Table 4.Limiting values

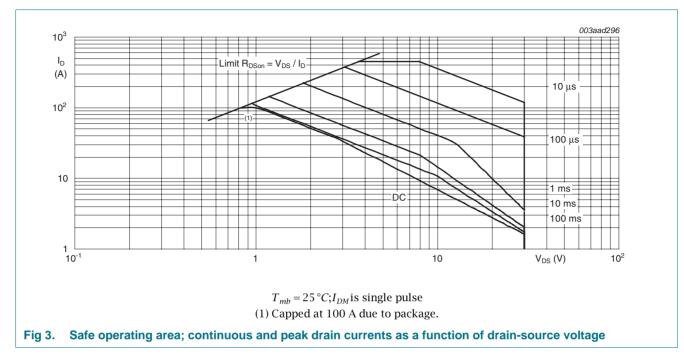
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	30	V
V _{DGR}	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$		-	30	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	V_{GS} = 10 V; T_{mb} = 100 °C; see <u>Figure 1</u>	[1]	-	80	А
		V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u>	[1]	-	100	А
I _{DM}	peak drain current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see <u>Figure 3</u>		-	465	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	103	W
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-dr	ain diode					
I _S	source current	T _{mb} = 25 °C	[1]	-	100	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	465	А
Avalanche	e ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_{D} = 100 A; V_{sup} \leq 30 V; R_{GS} = 50 $\Omega;$ unclamped		-	74	mJ

[1] Continuous current is limited by package.



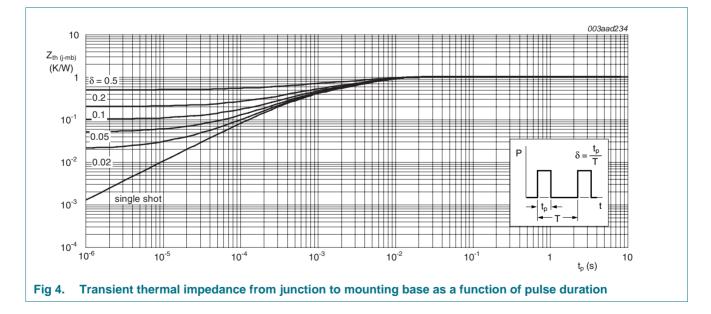
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5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see <u>Figure 4</u>	-	1	1.5	K/W



6. Characteristics

Table 6.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Static cha	aracteristics						
V _{(BR)DSS}	drain-source	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$		30	-	-	V
	breakdown voltage	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ\text{C}$		27	-	-	V
V _{GS(th)}	V _{GS(th)} gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 10</u> ; see <u>Figure 11</u>		1.3	1.7	2.15	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 11</u>		0.5	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see <u>Figure 11</u>		-	-	2.45	V
I _{DSS}	drain leakage current	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	1	μA
		$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	40	μA
I _{GSS}	gate leakage current	V_{GS} = 16 V; V_{DS} = 0 V; T_j = 25 °C		-	-	100	nA
		V_{GS} = -16 V; V_{DS} = 0 V; T_j = 25 °C		-	-	100	nA
R _{DSon}	drain-source on-state	V_{GS} = 4.5 V; I _D = 15 A; T _j = 25 °C	[2]	-	4.5	6.2	mΩ
	resistance	V_{GS} = 10 V; I_D = 15 A; T_j = 100 °C; see <u>Figure 12</u> ; see <u>Figure 13</u>		-	-	6	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 13;</u>	[2]	-	3.5	4.3	mΩ
R _G	gate resistance	f = 1 MHz		-	1	-	Ω
Dynamic	characteristics						
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 15 \text{ V}; V_{GS} = 4.5 \text{ V};$ see <u>Figure 14</u> ; see <u>Figure 15</u>		-	19	-	nC
		$I_D = 25 \text{ A}; V_{DS} = 15 \text{ V}; V_{GS} = 10 \text{ V};$ see Figure 14; see Figure 15		-	41.5	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 15 \text{ V}; V_{GS} = 4.5 \text{ V};$		-	8	-	nC
Q _{GS(th)}	pre-threshold gate-source charge	see <u>Figure 14;</u> see <u>Figure 15</u>		-	4	-	nC
$Q_{GS(th-pl)}$	post-threshold gate-source charge			-	4	-	nC
Q _{GD}	gate-drain charge			-	5	-	nC
V _{GS(pl)}	gate-source plateau voltage	V _{DS} = 15 V; see <u>Figure 14;</u> see Figure 15		-	2.7	-	V
C _{iss}	input capacitance	V _{DS} = 12 V; V _{GS} = 0 V; f = 1 MHz;		-	2400	-	рF
C _{oss}	output capacitance	T _j = 25 °C; see <u>Figure 16</u>		-	500	-	pF
C _{rss}	reverse transfer capacitance			-	240	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 20 \text{ V}; \text{ R}_{L} = 0.5 \Omega; \text{ V}_{GS} = 10 \text{ V};$		-	28	-	ns
t _r	rise time	$R_{G(ext)} = 5.6 \ \Omega$		-	58	-	ns
t _{d(off)}	turn-off delay time			-	44	-	ns
t _f	fall time			-	21	-	ns

PSMN4R3-30PL

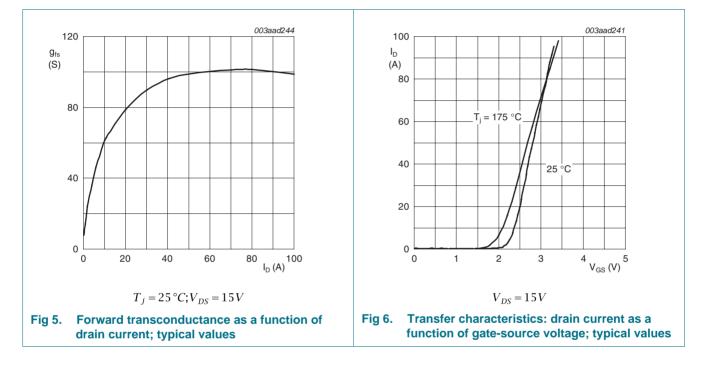
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Table 0.	Characteristics continued					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-d	rain diode					
V_{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 17</u>	-	0.81	1.2	V
t _{rr}	reverse recovery time	$I_{S} = 20 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$	-	35	-	ns
Qr	recovered charge	$V_{DS} = 30 V$	-	30	-	nC

Table 6. Characteristics ...continued

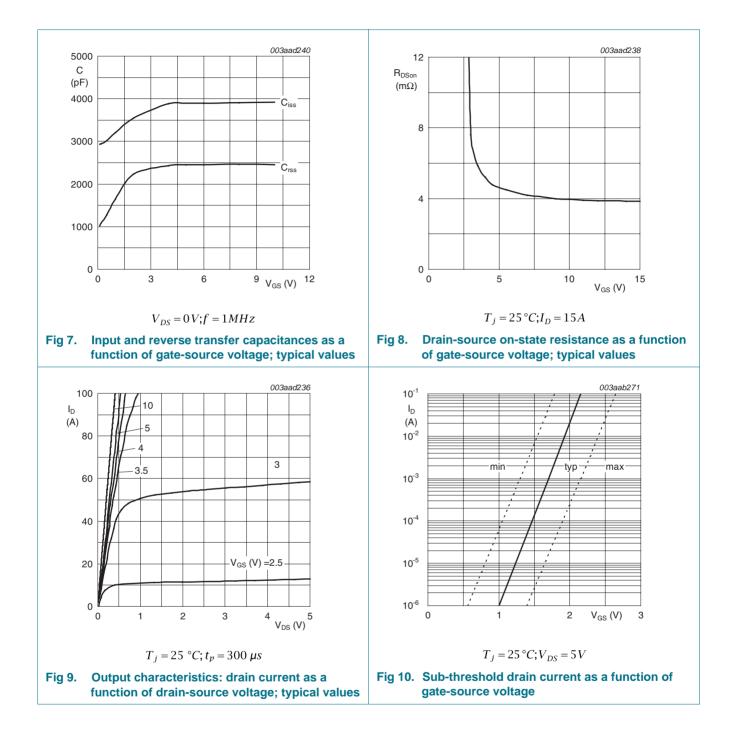
[1] Tested to JEDEC standards where applicable.

[2] Measured 3 mm from package.

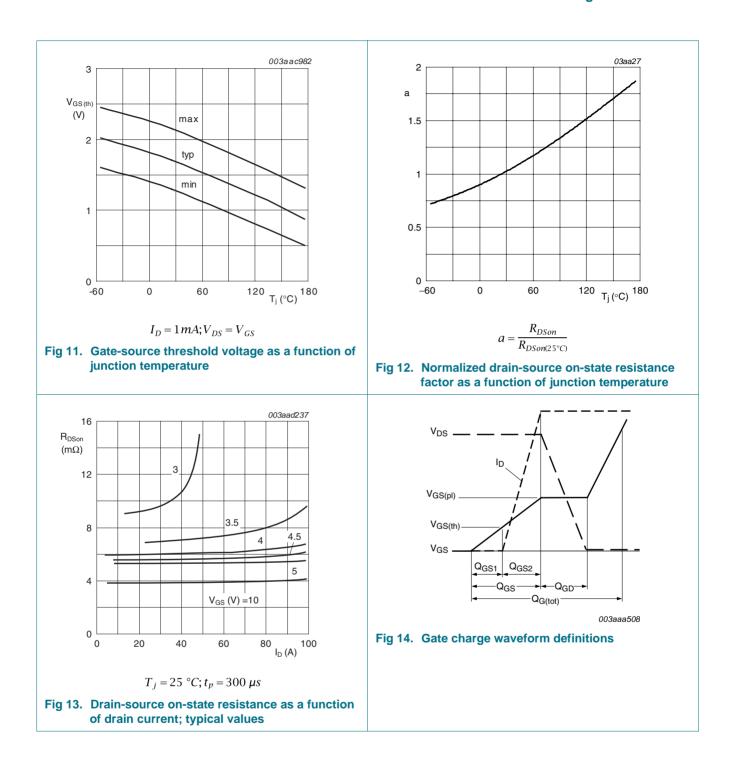


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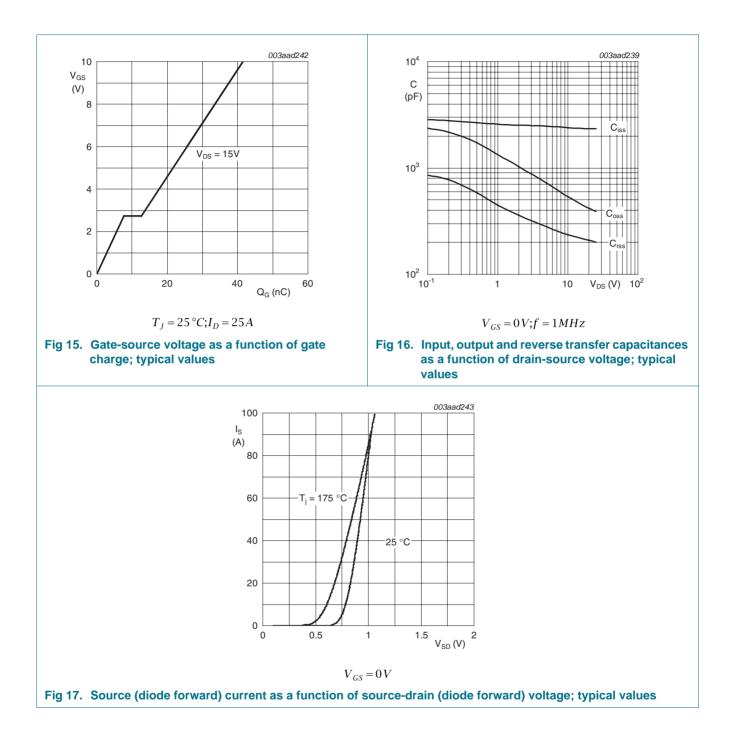
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7. Package outline

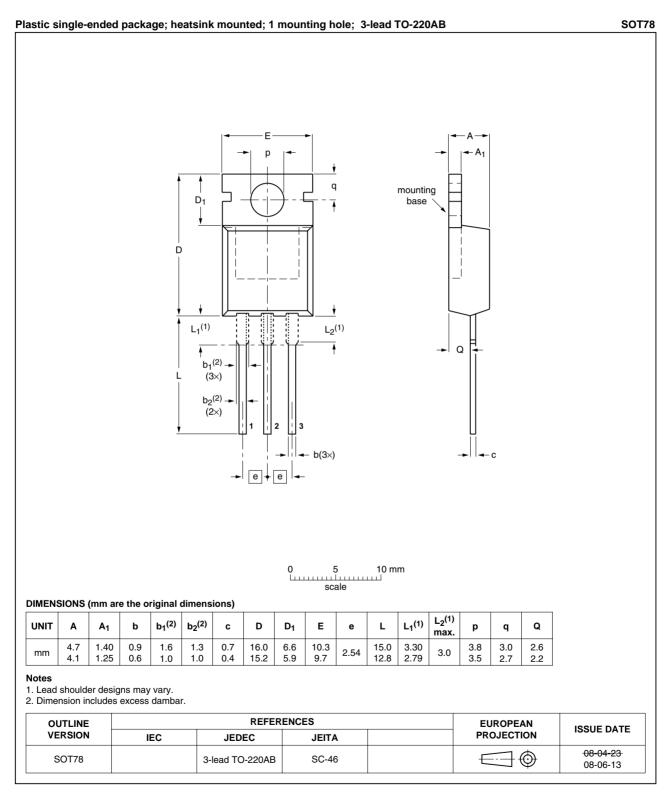


Fig 18. Package outline SOT78 (TO-220AB)

8. Revision history

Table 7. Revision hist	Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
PSMN4R3-30PL_1	20090616	Product data sheet	-	-	

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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